| ABSOLUTION CONNECTING<br>ELECTRONICS INDUSTRIES® INFORMATION AND PARTICIPATION CONNECTING | PC, Bannock   | burn, Illinois. A | ll rights reserved untions. | under both              | This docume<br>level parts, t                                     | ent is a decla<br>he declaratio | ration of the | e substances<br>sses all lowe  | within the<br>er level ma       | e manufacture<br>terials for wh | er listed it<br>hich the m | em. Note<br>anufactu | e: if the it<br>arer has er | em is an asse<br>ngineering re | mbly with lowe<br>sponsibility. |  |
|---|---|-------------------|-----------------------------|-------------------------|---|---------------------------------|---------------|--------------------------------|---------------------------------|---------------------------------|----------------------------|----------------------|-----------------------------|--------------------------------|---------------------------------|--|
|   | IPC Web Site for Information on IPC-1752 Standard Form Typ<br>http://www.ipc.org/IPC-175x Distributed |                   |                             |                         | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Mater |                                 |               |                                |                                 | eous Materia                    | ials and Mfg Information   |                      |                             |                                |                                 |  |
| Supplier Information  |   |                   |                             |                         |   |                                 |               |                                |                                 |                                 |                            |                      |                             |                                |                                 |  |
| Company name*   | Company unique ID   |                   |                             | Unique ID Authority     |   |                                 |               |                                | Response Date*                  |                                 |                            |                      |                             |                                |                                 |  |
| onsemi  |   |                   |                             |                         |   |                                 |               |                                |                                 |                                 |                            | 2024-05-03           |                             |                                |                                 |  |
| Contact Name  | Title - Contac  | Title - Contact   |                             |                         | Phone - Contact*  |                                 |               |                                |                                 | Email - Contact*                |                            |                      |                             |                                |                                 |  |
| Product-Env-Stewards  | Product Enviro Compliance   |                   |                             |                         | NA  |                                 |               |                                |                                 | Product-Env-Stewards@onsemi.com |                            |                      |                             |                                |                                 |  |
| Authorized Representative*  | Title - Representative  |                   |                             | Phone - Representative* |   |                                 |               | Email - Representative*        |                                 |                                 |                            |                      |                             |                                |                                 |  |
| Product-Env-Stewards  | Product Enviro Compliance   |                   |                             |                         | NA  |                                 |               |                                | Product-Env-Stewards@onsemi.com |                                 |                            |                      |                             |                                |                                 |  |
| Requester Item Number   | Mfr Iten  | n Number          | Mfr Item Name               |                         |   | Effective D                     | ate Versi     | on                             | n Manufacturing Site            |                                 | V                          | Veight*              | U                           | JOM                            | Unit Type                       |  |
|   | MC74L   | VX86DTR2G         | LOG CMOS GATE EXCLSV OR     |                         | )R  | 2024-05-03                      |               |                                | PH1                             |                                 | 4                          | 5.24                 | n                           | ıg                             | Each                            |  |
| Manufacturing Proccess Informa  | tion  |                   |                             |                         |   |                                 |               |                                |                                 |                                 |                            |                      |                             |                                |                                 |  |
| Terminal Plating / Grid Array M   | aterial   | Ferminal Base A   | Alloy                       | J-STD-020 MSL Ratin     |   | Peak Process H                  |               | ly Temperature Max Time at Pea |                                 | 'ime at Peak '                  | Temperature Num            |                      | lumber of Reflow Cycles     |                                |                                 |  |
| Precious metal (e.g. Ag,Au, NiPdAu) (no<br>Sn)  |   | CU Alloy 1        |                             | 1                       |   | 260                             |               | С                              | 30                              |                                 | second                     | seconds 3            |                             |                                |                                 |  |
| Comments  |   |                   |                             |                         |   |                                 |               |                                |                                 |                                 |                            |                      |                             |                                |                                 |  |
| evel 1 - maximum time at peak temperat  | ure during so   | ldering is 10-3   | 0 seconds                   |                         |   |                                 |               |                                |                                 |                                 |                            |                      |                             |                                |                                 |  |
| for more information regarding material   | composition   | please refer to   | page 3                      |                         |   |                                 |               |                                |                                 |                                 |                            |                      |                             |                                |                                 |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance                  | CAS              | Exempt | Weight  | Unit of Measure |
|----------------------|--------|-----------------|----------|----------------------------|------------------|--------|---------|-----------------|
| Die                  | 2.0    | mg              | Supplier | Silicon (Si)               | 7440-21-3        |        | 2       | mg              |
| Die Attach           | 1.44   | mg              | Supplier | Silver (Ag)                | 7440-22-4        |        | 1.08    | mg              |
|                      |        |                 | Supplier | Epoxy resins               | 129915-35-1      |        | 0.36    | mg              |
| Lead Frame           | 22.54  | mg              | Supplier | Iron (Fe)                  | 7439-89-6        |        | 0.4283  | mg              |
|                      |        |                 | Supplier | Copper (Cu)                | 7440-50-8        |        | 22.1117 | mg              |
| Mold Compound-Black  | 19.0   | mg              |          | Epoxy resin                | proprietary data |        | 0.95    | mg              |
|                      |        |                 | Supplier | Phenolic Resin             | Proprietary Data |        | 0.95    | mg              |
|                      |        |                 | Supplier | Ortho Cresol Novolac Resin | 29690-82-2       |        | 0.38    | mg              |
|                      |        |                 | Supplier | Carbon Black (C)           | 1333-86-4        |        | 0.095   | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)        | 60676-86-0       |        | 16.625  | mg              |
| Plating              | 0.04   | mg              | Supplier | Palladium (Pd)             | 7440-05-3        |        | 0.003   | mg              |
|                      |        |                 | В        | Nickel (Ni)                | 7440-02-0        |        | 0.0364  | mg              |
|                      |        |                 | Supplier | Gold (Au)                  | 7440-57-5        |        | 0.0006  | mg              |
| Wire Bond - Au       | 0.22   | mg              | Supplier | Gold (Au)                  | 7440-57-5        |        | 0.22    | mg              |